# **UF3A THRU UF3M**

# SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER



REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 3.0 AMPERE

#### **FEATURES**

· Plastic package has Underwriters Laboratory

Flammability Classification 94V-O

- · For surface mounted applications
- · Low profile package
- · Easy pick and place
- · Built-in strain relief
- · Ultrafast recovery times for high efficiency
- · High temperature soldering: 250°C/10 seconds at terminals

### **MECHANICAL DATA**

Case: Molded plastic, DO-214AB(SMC)

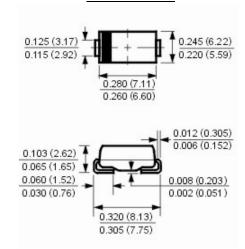
Terminals: Solder plated, solderable per MIL-STD-750,

method 2026 guaranteed

Polarity: Color band denotes cathode end Packaging: 16mm tape per EIA STD RS-481

Weight: 0.007 ounce, 0.21 gram

### DO-214AB(SMC)



**Dimensions in inches and (millimeters)** 

## Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave,  $60H_Z$ , resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	UF3A	UF3B	UF3D	UF3G	UF3J	UF3K	UF3M	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T <sub>L</sub> =75℃	$I_{(AV)}$				3.0				Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I <sub>FSM</sub> 100							Amp	
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 3.0A	$V_{F}$		1.0		1.3		1.7		Volts
Maximum Reverse Current at $T_A=25^{\circ}\mathbb{C}$ at Rated DC Blocking Voltage $T_A=100^{\circ}\mathbb{C}$	$I_R$	5.0 300							μAmp
Typical Junction Capacitance (Note 1)	$C_{J}$	75 63					pF		
Typical Thermal Resistance (Note 2)	$R_{ heta JL}$	15							°C/W
Maximum Reverse Recovery Time (Note 3)	$T_{RR}$	50 75					nS		
Operating Junction Temperature Range	$T_{J}$	-55 to +150							င
Storage Temperature Range	Tstg	-55 to +150							ဗ

#### **NOTES:**

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas
- 3- Reverse Recovery Test Conditions:  $I_F$ =.5A,  $I_R$ =1A,  $I_{RR}$ =.25A.



#### RATINGS AND CHARACTERISTIC CURVES

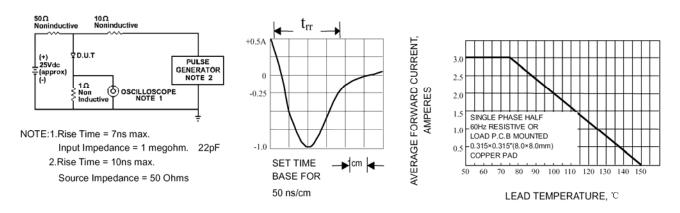


Fig. 1-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

Fig. 2-MAXIMUM AVERAGE FORWARD CURRENT RATING

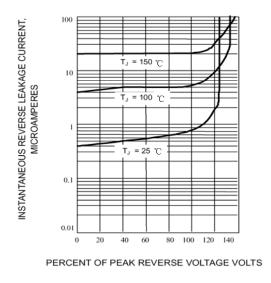
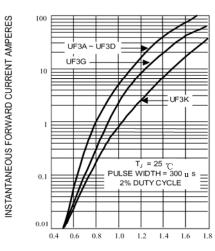


Fig. 3-TYPICAL REVERSE CHARACTERISTICS



INSTANTANEOUS FORWARD VOLTAGE VOLTS

Fig. 4-TYPICAL FORWARD CHARACTERISTICS

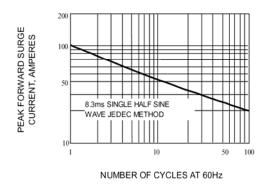


Fig. 5-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

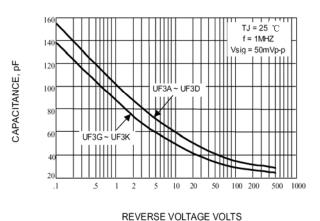


Fig. 6-TYPICAL JUNCTION CAPACITANCE